



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 10/630,427  
Filing Date ..... July 29, 2003  
Inventor..... Wendell P. Noble  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2813  
Examiner ..... Laura M. Schillinger  
Attorney's Docket No. ..... MI22-2378  
Customer No. ..... 021567  
Title: Methods of Forming Conductive Lines

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Reference -See Attached Form PTO-1449

The Examiner's attention is directed to the references which are listed on the attached Form PTO-1449, a copy of which is attached. Copies of the cited U.S. patents are not included (1273 Off. Gaz. Pat. Off. 55, 05 August 2003). No admission is made regarding whether all the submitted references are prior art.

Citation of the referenced art is respectfully requested.

Respectfully submitted,

Dated: 4/18/05

By: RC Hyta  
Robert C. Hyta  
Reg. No. 46,791

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Form PTO-1449

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(Use several sheets if necessary)ATTY. DOCKET NO.  
MI22-2378SERIAL NO.  
10/630,427APPLICANT  
Wendell P. NobleFILING DATE  
July 29, 2003GROUP  
2813

## U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	6,111,310	08/00	Schultz	257	691	
	AB	6,388,332 B1	05/02	Aggarwal et al.	257	774	
	AC	6,586,828 B2	07/03	Buffet et al.	257	691	
	AD	6,778,398 B2	08/04	Wyland	361	720	
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						

## FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Clas s	Subcl ass	Translation	
							Yes	No
	AK							
	AL							
	AM							

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

AN	
AO	
AP	
EXAMINER	DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.